



Parameter	Ratings	Units
Blocking Voltage	600	V_P
Load Current	500	mA_{rms}
On State Voltage Drop	1.4	V_{rms} (at $I_L = 500mA$)

Features

- Load Current up to $0.5A_{rms}$
- $600V_P$ Blocking Voltage
- 5mA Sensitivity
- Zero-Crossing Detection
- DC Control, AC Output
- Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- Machine Insertable, Wave Solderable
- Flammability Classification Rating of V-0

Applications

- Programmable Control
- Process Control
- Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

Description

The CPC1963 is an AC Solid State Switch using optical coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The CPC1963 switches are robust enough to provide a blocking voltage of up to $600V_P$. In addition, tightly controlled zero cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide $3750V_{rms}$ of isolation and noise immunity between control and load circuits. As a result, the CPC1963 is well suited for industrial environments where electromagnetic interference could disrupt the operation of electromechanical relays.

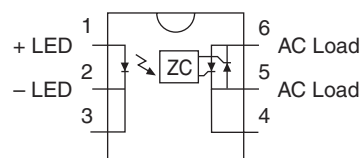
Approvals

- UL Recognized Component: File E69938
- CSA Certified Component: Certificate 1172007

Ordering Information

Part Number	Description
CPC1963G	6-Pin DIP (50/Tube)
CPC1963GS	6-Pin Surface Mount (50/Tube)
CPC1963GSTR	6-Pin Surface Mount (1000/Reel)

Pin Configuration



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	600	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	150	mW
Total Package Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Operating Voltage Range	V _T	-	20	-	260	V _{rms}
Load Current, Continuous	V _L =120V _{rms}	I _L	0.005	-	0.5	A _{rms}
Off State Leakage Current	V = 600V	I _{LEAK}	-	-	1	mA
On-State Voltage Drop	I _L =500 mA _{rms}	V _{ON}	-	-	1.4	V _{rms}
Critical Rate of Rise ³	-	dV/dt	1000	-	-	V/μs
Switching Speeds	I _F =5 mA	t _{on}	-	-	0.5	cycles
Turn-on						
Turn-off		t _{off}	-	-	0.5	
Zero-Cross Turn-On Voltage ¹	1st half-cycle	-	-	2	10	V
	Subsequent half-cycle	-	-	1	-	
Operating Frequency	-	-	20	-	500	Hz
Load Power Factor for Guaranteed Turn-On ²	-	PF	0.25	-	-	-
Input Characteristics						
Input Control Current to Activate ⁴	-	I _F	-	0.23	5	mA
Input Drop-out Voltage	-	-	0.8	-	-	V
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

¹ Zero Cross 1st half-cycle @ <100Hz

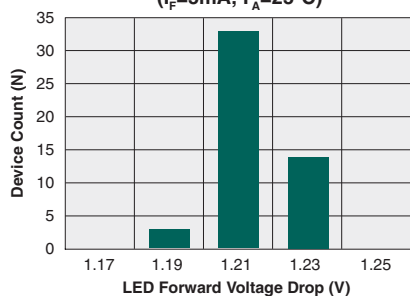
² Snubber circuits may be required at low power factors.

³ Tested in accordance with EIA/NARM standard RS-443.

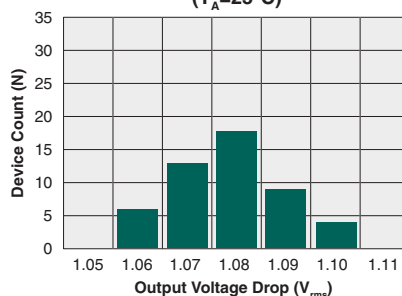
⁴ For high noise environments use at least 10mA LED current.

PERFORMANCE DATA*

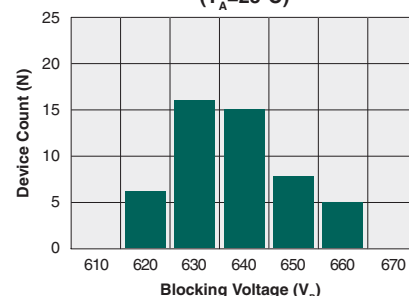
Typical LED Forward Voltage Drop
($I_F=5\text{mA}$, $T_A=25^\circ\text{C}$)



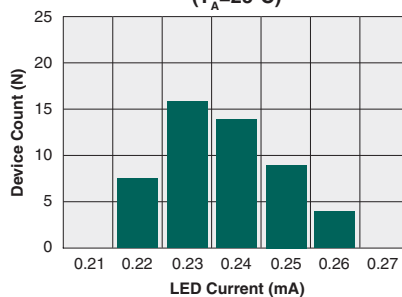
Typical On-State
Output Voltage Drop Distribution
($T_A=25^\circ\text{C}$)



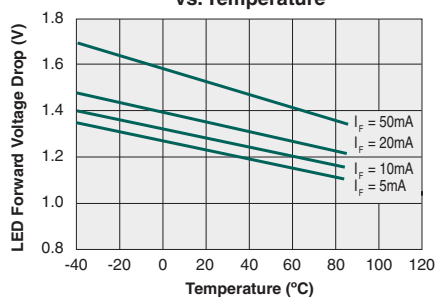
Typical Blocking Voltage Distribution
($T_A=25^\circ\text{C}$)



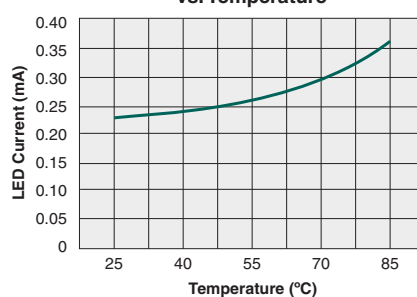
Typical I_F for Switch Operation
($T_A=25^\circ\text{C}$)



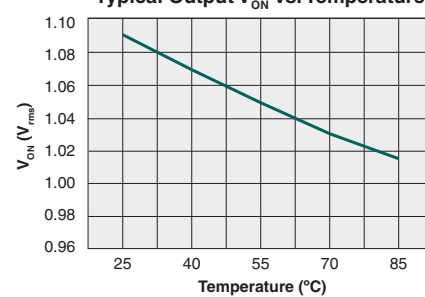
Typical LED Forward Voltage Drop
vs. Temperature



Typical I_F for Switch Operation
vs. Temperature

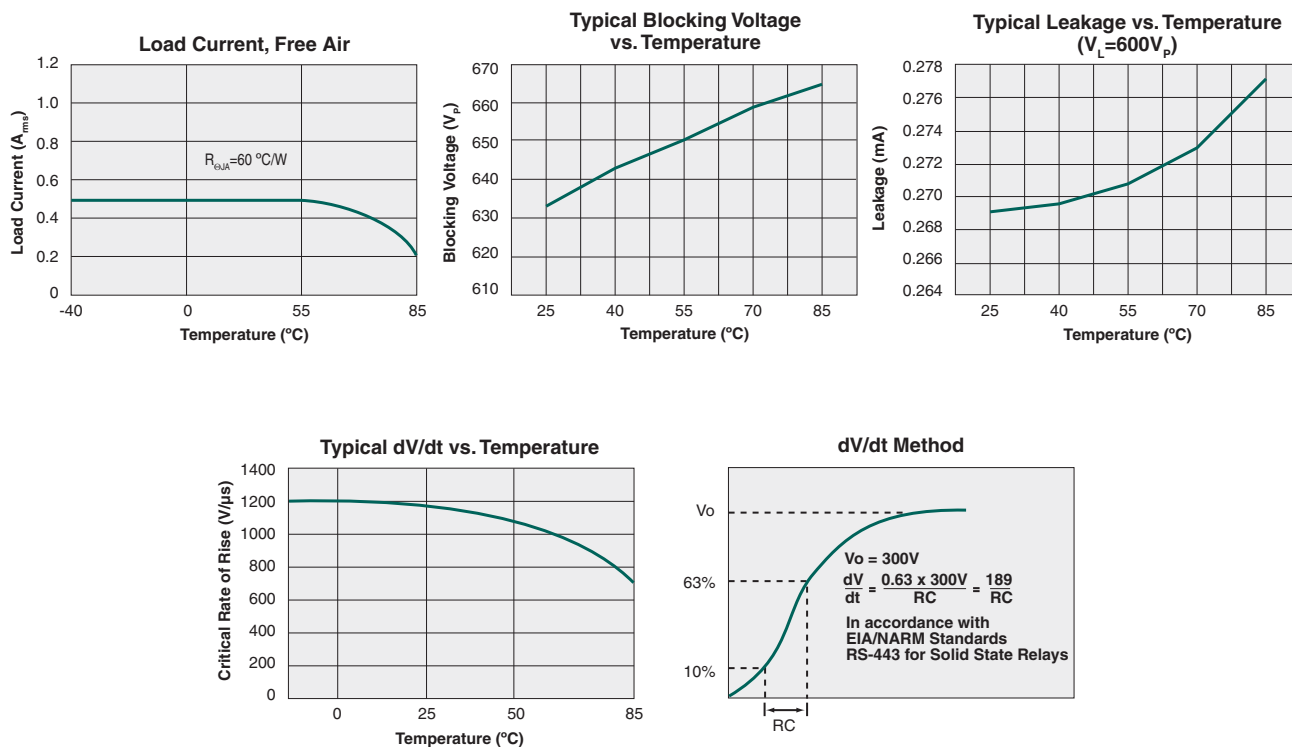


Typical Output V_{ON} vs. Temperature



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*



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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1963G / CPC1963GS	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1963G / CPC1963GS	250°C for 30 seconds

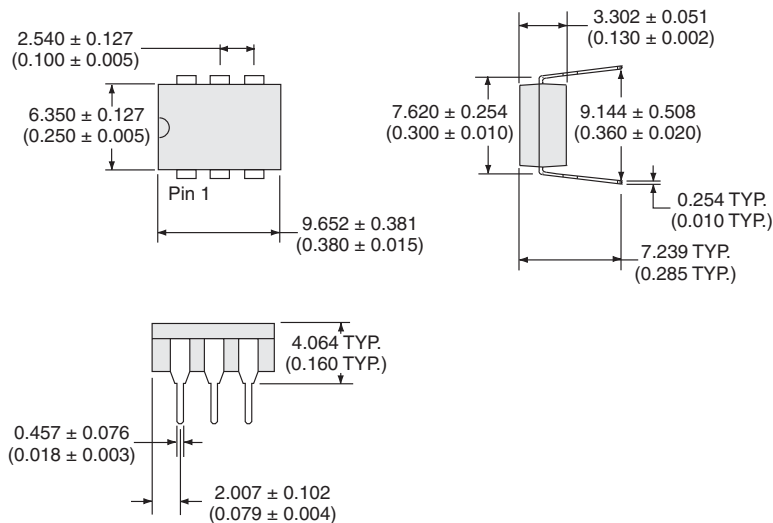
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

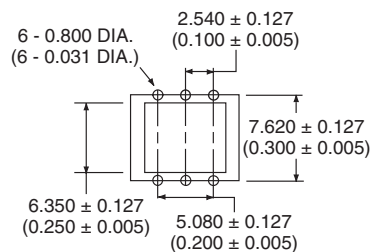


MECHANICAL DIMENSIONS

CPC1963G

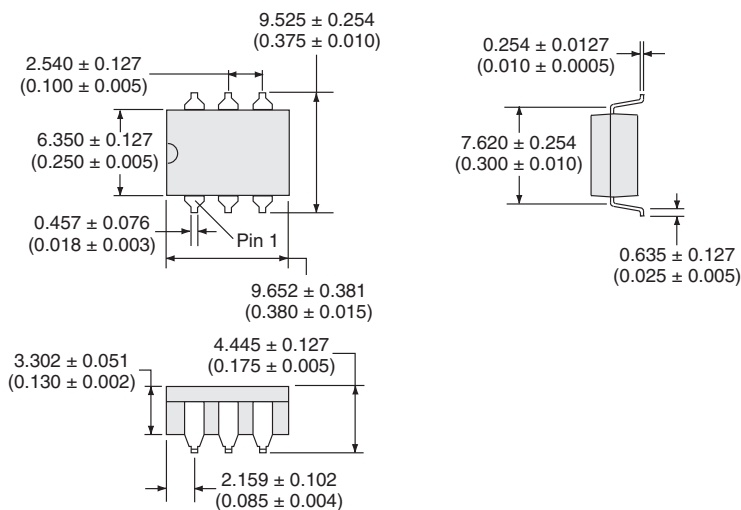


PCB Hole Pattern

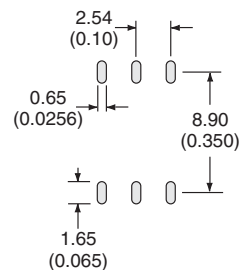


Dimensions
mm
(inches)

CPC1963GS

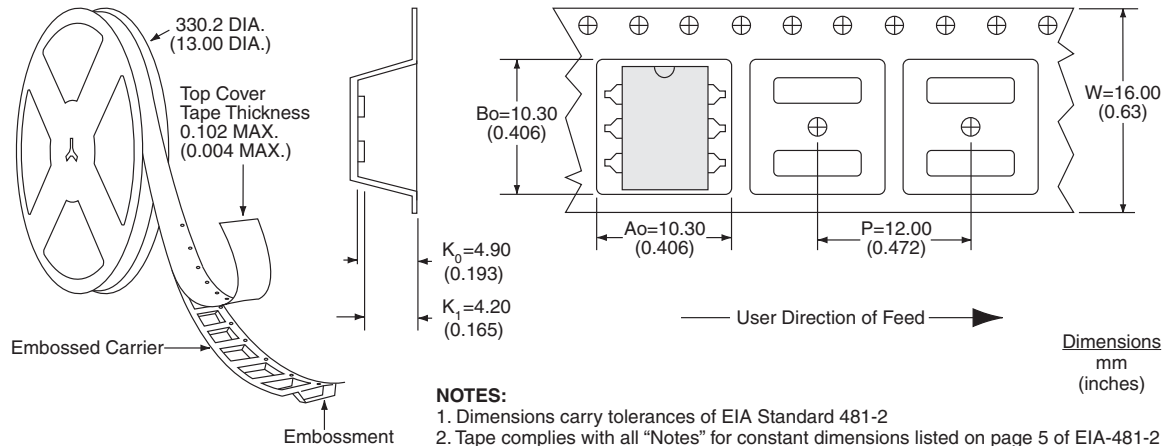


PCB Land Pattern



Dimensions
mm
(inches)

CPC1963GS Tape & Reel



For additional information please visit our website at: www.ixysic.com

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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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